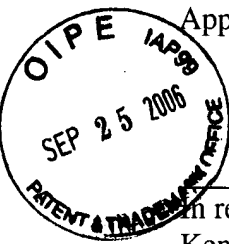


IFW

Application No.: 10/530,722

Docket No.: SNC-0217  
(85344-0217)



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Kenji Okura

Application No.: 10/530,722

Confirmation No.: 9964

Filed: April 8, 2005

Art Unit: 3723

For: BOTH SIDE GRINDING METHOD  
AND BOTH SIDE GRINDING MACHINE  
FOR THIN DISC WORK

Examiner: Robert J. Scruggs

**STATEMENT OF THE SUBSTANCE OF THE INTERVIEW**

MS ISSUE FEE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

This is in response to the Interview Summary mailed on August 28, 2006.

Appreciation is expressed to the Examiner for initiating an interview on August 22, 2006 to discuss the Abstract of the Disclosure. During that interview, the Examiner discussed changes to the Abstract which was reformatted in accordance with standard practices set forth in MPEP §608.01(b). We authorized the Examiner's Amendment as set forth in the allowing papers mailed August 28, 2006.

Application No.: 10/530,722

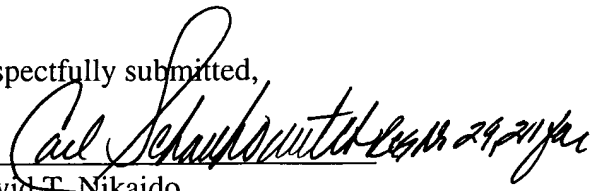
Docket No.: SNC-0217  
(85344-0217)

If any fee is required or any overpayment made, the Commissioner is hereby authorized to charge the fee or credit the overpayment to Deposit Account # 18-0013.

Dated: September 25, 2006

Respectfully submitted,

By

  
David T. Nikaido

Registration No.: 22,663  
RADER, FISHMAN & GRAUER PLLC  
1233 20th Street, N.W., Suite 501  
Washington, DC 20036  
(202) 955-3750